

DECLARATION

As a below named inventor, we hereby declare that:

My residence, post office address and citizenship are as stated below next to my name; that

We verily believe we are the original, first and sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are named below) of the invention entitled: **CAPACITOR WITH HIGH DIELECTRIC CONSTANT MATERIALS AND METHOD OF MAKING** (MIO 0062 PA/98-1296), described and claimed

 X in the attached specification;
 in the specification filed , as U.S. Application Serial No.
 , and as amended .

We hereby authorize the attorney(s) and/or agent(s) appointed herein to indicate above whether the invention is described and claimed in an attached specification and to provide the Filing Date and Serial No. of the corresponding U.S. Application, if previously filed.

We hereby state that we have reviewed and understand the contents of the above identified specification, including the claims as filed and as amended by any amendment referred to above.

We acknowledge the duty to disclose to the Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56(a).

We further declare that all statements made herein of our own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under §1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

09903150-074104

Full name of sole or first Inventor: **Cem Basceri**

Inventor's signature Cem Basceri

Date: 6-20-01

Residence: ~~3236 Gekeler Lane~~ ^{314 E. Iowa Dr. ^{CB}}
~~Apt B-204~~ ^{Boise, ID 83706}
Boise, ID 83706

Citizenship: Turkey

Post Office Address: c/o Micron Technology, Inc.
8000 S. Federal Way
Boise, ID 83706-9632

Full name of second Inventor: **Gurtej S. Sandhu**

Inventor's signature Gurtej S. Sandhu

Date: 6/20/01

Residence: 2964 East Parkriver Drive
Boise, ID 83706

Citizenship: United Kingdom

Post Office Address: c/o Micron Technology, Inc.
8000 S. Federal Way
Boise, ID 83706-9632

0900150-07110

Full name of third Inventor: Sam Yang

Inventor's signature

Date:

6/26/01

Residence: 5923 S. Sweet Gum Way
Boise, ID 83716

Citizenship: Chinese

Post Office Address: c/o Micron Technology, Inc.
8000 S. Federal Way
Boise, ID 83706-9632

0903160.071101

POWER OF ATTORNEY

Applicant: Cem Basceri, Gurtej Sandhu and Sam Yang

Application No.: _____ Filed: _____

Entitled: **CAPACITOR WITH HIGH DIELECTRIC CONSTANT MATERIALS AND METHOD OF MAKING (Docket No. MIO 0062 PA)**

CERTIFICATE UNDER 37 CFR 3.73(b)

Micron Technology, Inc., a corporation of the State of Delaware, with a place of business at 8000 S. Federal Way, Boise, ID 83706-9632 certifies that it is the assignee of the entire right, title and interest in the patent application identified above by virtue of either:

A. ☒ An assignment from the inventor(s) of the patent application identified above, a copy of which is attached.

OR

B. ☐ A chain of title from the inventor(s), of the patent application identified above, to the current assignee as shown below:

1. From: _____ To: _____
The document was recorded in the Patent and Trademark Office at
Reel _____ Frame _____, or for which a copy thereof is attached.

2. From: _____ To: _____
The document was recorded in the Patent and Trademark Office at
Reel _____ Frame _____, or for which a copy thereof is attached.

3. From: _____ To: _____
The document was recorded in the Patent and Trademark Office at
Reel _____ Frame _____, or for which a copy thereof is attached.

☐ Additional documents in the chain of title are listed on a supplemental sheet.

☐ Copies of assignments or other documents in the chain of title are attached.

The undersigned has reviewed all the documents in the chain of title of the patent application identified above and, to the best of undersigned's knowledge and belief, title is in the assignee identified above.

The undersigned (whose title is supplied below) is empowered to sign this certificate on behalf of the assignee.

009903150-071101

Micron Technology, Inc. hereby appoints the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Richard A. Killworth	Reg. No. 26,397
James F. Gottman	Reg. No. 27,262
Timothy W. Hagan	Reg. No. 29,001
James E. Beyer	Reg. No. 39,564
Susan M. Luna	Reg. No. 38,769
Patricia L. Prior	Reg. No. 33,758
William A. Jividen	Reg. No. 42,695
Thomas E. Lees	Reg. No. 46,867
John D. Reed	Reg. No. 46,506
Brian L. Smiler	Reg. No. 46,458
Julie G. Cope	Reg. No. P-48,624
Michael L. Lynch	Reg. No. 30,871
Charles B. Brantley, II.	Reg. No. 38,086

Address all telephone calls to (937) 223-2050. Address all correspondence to: KILLWORTH, GOTTMAN, HAGAN & SCHAEFF, L.L.P., One Dayton Centre, One South Main Street, Suite 500, Dayton, Ohio 45402-2023.

Micron Technology, Inc. hereby declares that all statements made herein of my own knowledge are true, and that all statements made on information and belief are believed to be true; and further, that these statements are made with the knowledge that willful false statements, and the like so made, are punishable by fine or imprisonment, or both, under Section 1001, Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 7/2/01

Name: Michael L. Lynch

Title: Chief Patent Counsel

Signature: 

ASSIGNMENT

WHEREAS, we, **CEM BASCERI**, of Boise, Idaho, **GURTEJ S. SANDHU**, of Boise, Idaho, and **SAM YANG**, of Boise, Idaho, invented certain new and useful **CAPACITOR WITH HIGH DIELECTRIC CONSTANT MATERIALS AND METHOD OF MAKING** for which we executed an application for a United States Patent and for which said application for United States Patent was filed on _____, under

☐ Patent Application Serial No. _____

☒ Attorney Docket No. MIO 0062 PA;

WHEREAS, we hereby authorize and request the attorney(s) and/or agent(s) empowered to act on our behalf in the aforementioned application, to insert above the filing date and application number of said application, when known;

AND WHEREAS, Micron Technology, Inc., a corporation of the State of Delaware, with a place of business at 8000 S. Federal Way, Boise, Idaho 83706-9632, hereinafter called the Assignee, is desirous of acquiring the entire right, title and interest in and to said application and the inventions therein disclosed and any letters patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, receipt whereof is hereby acknowledged, we hereby sell, assign and transfer unto said Assignee, its successors and assigns, the entire right, title and interest in and to said application and any divisions or continuations thereof, and the inventions therein disclosed, and any improvements thereon, and any patent or patents that may be issued or reissued thereon, and we hereby authorize and request the Commissioner of Patents and Trademarks to issue any letters patent thereon, and reissues thereof, to said Assignee, its successors and assigns; and we hereby authorize said Assignee, its successors and assigns, to file in its own name applications for patent in foreign countries in connection with the inventions hereby transferred, under the International Convention claiming the priority of said United States application or otherwise, and to secure in its own name the patent or patents issued thereon; and we hereby agree that, upon request, we will sign all papers, and make all rightful oaths, and do all acts which said Assignee, its successors or assigns, may consider necessary in connection with said United States application, and in connection with any other United States or foreign applications that may be filed in connection with said inventions, and with any improvements thereon, and in connection with any patents issued or reissued thereon.

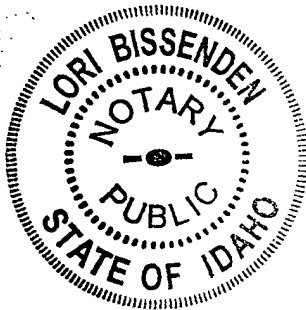
IN TESTIMONY WHEREOF, we hereunto set our hand and seal this 20th day
of June, 2001.

Cem Basceri 6-20-01
CEM BASCERI

Gurtej Sandhu 6/20/01
GURTEJ S. SANDHU

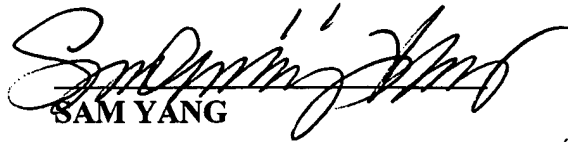
State of Idaho)
County of Ada) ss

On this 20th day of June, 2001 before me a Notary Public in and for
the above County and State, personally appeared the above named **CEM BASCERI and**
GURTEJ S. SANDHU personally known to me, and acknowledged the execution of the
foregoing assignment as a free act and deed for the purpose herein set forth.



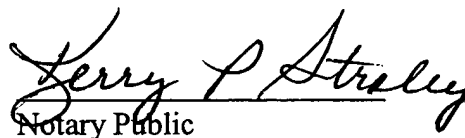
Lori Bissenden
Notary Public

IN TESTIMONY WHEREOF, we hereunto set our hand and seal this 26 day of June, 2001.


SAM YANG

State of New York)
County of Dutchess) ss

On this 26 day of June, 2001 before me a Notary Public in and for the above County and State, personally appeared the above named **SAM YANG** personally known to me, and acknowledged the execution of the foregoing assignment as a free act and deed for the purpose herein set forth.


Notary Public

